CMLDM7002A CMLDM7002AG* CMLDM7002AJ

SURFACE MOUNT SILICON **DUAL N-CHANNEL ENHANCEMENT-MODE MOSFETS**



cen Semiconductor Corp

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DESCRIPTION:

These CENTRAL SEMICONDUCTOR devices are dual N-Channel enhancement-mode MOSFETs, manufactured by the N-Channel DMOS Process, designed for high speed pulsed amplifier and driver applications. The CMLDM7002A utilizes the USA pinout configuration, while the CMLDM7002AJ utilizes the Japanese pinout configuration. These devices offer low rDS (ON) and low VDS(ON).

	SOT-563 CASE		DDES: CMLDM70024 CMLDM70024				
	* Device is <i>Halogen Free</i> by design		CMLDM7002A	AJ: 02J			
	MAXIMUM RATINGS: (T _A =25°C)	SYMBOL		UNITS			
	Drain-Source Voltage	V _{DS}	60	V			
	Drain-Gate Voltage	V _{DG}	60	V			
	Gate-Source Voltage	V _{GS}	40	V			
	Continuous Drain Current	۱ _D	280	mA			
	Continuous Source Current (Body Diode)	۱ _S	280	mA			
	Maximum Pulsed Drain Current	IDM	1.5	А			
	Maximum Pulsed Source Current	ISM	1.5	А			
	Power Dissipation (Note 1)	Ρ _D	350	mW			
	Power Dissipation (Note 2)	Ρ _D	300	mW			
	Power Dissipation (Note 3)	Ρ _D	150	mW			
	Operating and Storage Junction Temperature	T _J , T _{stg}	-65 to +150	°C			
	Thermal Resistance	Θ_{JA}	357	°C/W			
ELECTRICAL CHARACTERISTICS PER TRANSISTOR: (TA=25°C unless otherwise noted)							
	SYMBOL TEST CONDITIONS	MIN	MAX	UNITS			
	IGSSF, IGSSR VGS=20V, VDS=0		100	nA			
	1 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 - 2 -		1.0				

IGSSF, IGSSR	VGS=20V, VDS=0		100	nA
IDSS	V _{DS} =60V, V _{GS} =0		1.0	μA
IDSS	V _{DS} =60V, V _{GS} =0, T _J =125°C		500	μA
I _{D(ON)}	V _{GS} =10V, V _{DS} =10V	500		mA
BVDSS	V _{GS} =0, I _D =10µA	60		V
V _{GS(th)}	V _{DS} =V _{GS} , I _D =250µA	1.0	2.5	V
VDS(ON)	V _{GS} =10V, I _D =500mA		1.0	V
V _{DS(ON)}	V _{GS} =5.0V, I _D =50mA		0.15	V
V _{SD}	V _{GS} =0, I _S =400mA		1.2	V
^r DS(ON)	V _{GS} =10V, I _D =500mA		2.0	Ω
rDS(ON)	V _{GS} =10V, I _D =500mA, T _J =125°C		3.5	Ω
rDS(ON)	V _{GS} =5.0V, I _D =50mA		3.0	Ω
rDS(ON)	V _{GS} =5.0V, I _D =50mA, T _J =125°C		5.0	Ω
9FS	V _{DS} =10V, I _D =200mA	80		mS

Notes: (1) Ceramic or aluminum core PC Board with copper mounting pad area of 4.0mm² (2) FR-4 Epoxy PC Board with copper mounting pad area of 4.0mm² (3) FR-4 Epoxy PC Board with copper mounting pad area of 1.4mm²

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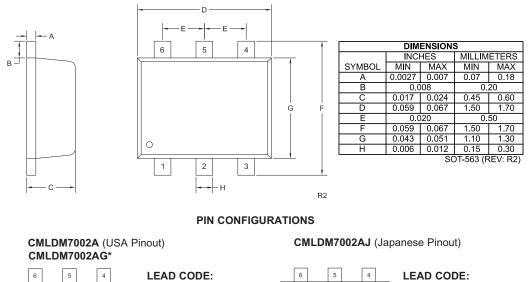


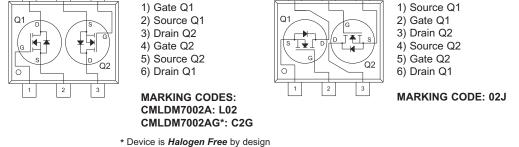


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ELECTRICA	L CHARACTERISTICS PER TRANSISTO	R - Continued: (T _A	=25°C unless ot	nerwise noted)
SYMBOL	TEST CONDITIONS	TYP	MAX	UNITS
C _{rss}	V _{DS} =25V, V _{GS} =0, f=1.0MHz		5.0	pF
C _{iss}	V _{DS} =25V, V _{GS} =0, f=1.0MHz		50	pF
Coss	V _{DS} =25V, V _{GS} =0, f=1.0MHz		25	pF
Q _{g(tot)}	V _{DS} =30V, V _{GS} =4.5V, I _D =100mA	0.592		nC
Qgs	V _{DS} =30V, V _{GS} =4.5V, I _D =100mA	0.196		nC
Q _{gd}	V _{DS} =30V, V _{GS} =4.5V, I _D =100mA	0.148		nC
t _{on} , t _{off}	V _{DD} =30V, V _{GS} =10V, I _D =200mA			
	R _G =25Ω, R _L =150Ω		20	ns

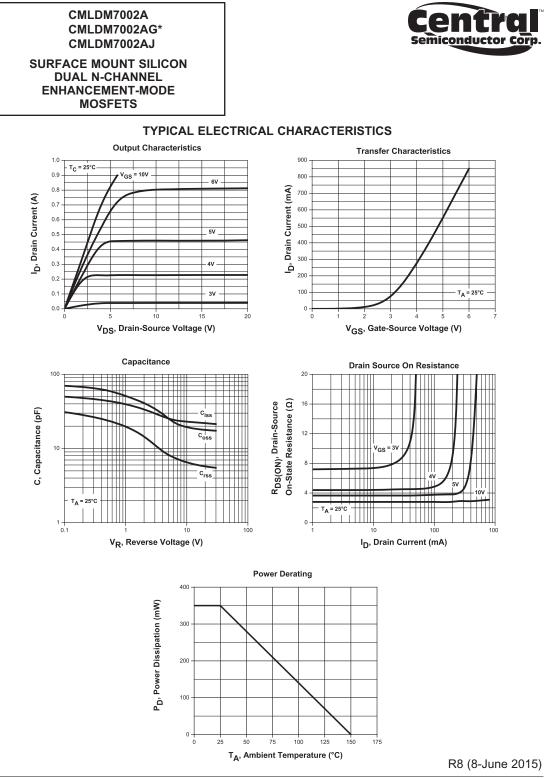
SOT-563 CASE - MECHANICAL OUTLINE





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